

UNISONIC TECHNOLOGIES CO., LTD

4N70 Power MOSFET

4.4A, 700V N-CHANNEL POWER MOSFET

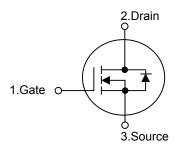
DESCRIPTION

The UTC 4N70 is a high voltage power MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche. This high speed switching power MOSFET is usually used in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

FEATURES

- * $R_{DS(ON)} = 2.8\Omega @V_{GS} = 10 \text{ V}$
- * Ultra Low Gate Charge (Typical 15nC)
- * Low Reverse Transfer Capacitance (C_{RSS} = Typical 8.0 pF)
- * Fast Switching Capability
- * Avalanche Energy Specified
- * Improved dv/dt Capability, High Ruggedness

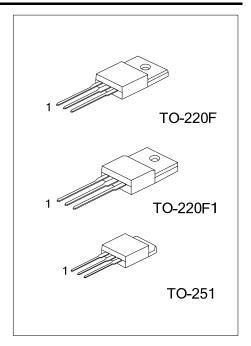




ORDERING INFORMATION

	Ordering	Dookogo	Pin Assignment			Dooking		
	Lead Free	Halogen Free	Package	1 2		3	Packing	
	4N70L-TF1-T	4N70G-TF1-T	TO-220F1	G	D	S	Tube	
	4N70L-TF3-T			G	D	S	Tube	
	4N70L-TM3-T			G	D	S	Tube	
N	Note: Pin Assignment: G: Gate D: Drain S: Source							

4N70<u>L</u>-<u>TF1</u>-<u>T</u> (1) T: Tube (1) Packing Type (2) TF1: TO-220F1, TF3: TO-220F, (2) Package Type TM3: TO-251 (3) Lead Free (3) G: Halogen Free, L: Lead Free



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■ **ABSOLUTE MAXIMUM RATINGS** (T_A = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	700	V
Gate-Source Voltage		V_{GSS}	±30	V
Avalanche Current (Note 2)		I_{AR}	4.4	Α
Duain Cumant	Continuous	I _D	4.4	Α
Drain Current	Pulsed (Note 2)	I_{DM}	17.6	Α
Avalancha Energy	Single Pulsed (Note 3)	E _{AS}	260	mJ
Avalanche Energy	Repetitive (Note 2)	E_AR	10.6	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns
Dawer Dissipation	TO-220F/TO-220F1	J	36	14/
Power Dissipation	TO-251	P_{D}	49	W
Junction Temperature		T_J	+150	°C
Operating Temperature		T_OPR	-55 ~ +150	°C
Storage Temperature		T_{STG}	-55 ~ + 150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating : Pulse width limited by maximum junction temperature
- 3. L = 26.9mH, I_{AS} = 4.4A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25°C
- 4. $I_{SD} \le 4.4A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT	
long attack to Analyticat	TO-220F/TO-220F1	0	62.5	°C/W	
Junction to Ambient	TO-251	θ_{JA}	110		
lunation to Case	TO-220F/TO-220F1	θ_{Jc}	3.47	°C/M	
Junction to Case	TO-251		2.55	°C/W	

■ **ELECTRICAL CHARACTERISTICS** (T_A =25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage		BV _{DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	700			V	
Drain-Source Leakage Current		I _{DSS}	$V_{DS} = 700 \text{ V}, V_{GS} = 0 \text{ V}$			10	μA	
Gate-Source Leakage Current	Forward	I _{GSS}	$V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA	
Gate-Source Leakage Current	Reverse		$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$			-100	11/	
Breakdown Voltage Temperature	Coefficient	$\triangle BV_{DSS}/\triangle T_{J}$	I _D = 250μA, Referenced to 25°C		0.6		V/°C	
ON CHARACTERISTICS								
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V	
Static Drain-Source On-State Res	istance	R _{DS(ON)}	$V_{GS} = 10 \text{ V}, I_D = 2.2 \text{ A}$		2.6	2.8	Ω	
DYNAMIC CHARACTERISTICS								
Input Capacitance		C _{ISS}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1MHz		520	670	pF	
Output Capacitance		Coss			70	90	pF	
Reverse Transfer Capacitance		C_{RSS}	1 - 1101112		8	11	pF	
SWITCHING CHARACTERISTIC	S							
Turn-On Delay Time		$t_{D(ON)}$			13	35	ns	
Turn-On Rise Time		t _R	$V_{DD} = 350V, I_D = 4.4A,$		45	100	ns	
Turn-Off Delay Time		t _{D(OFF)}	$R_G = 25\Omega$ (Note 1, 2)		25	60	ns	
Turn-Off Fall Time		t_{F}			35	80	ns	
Total Gate Charge		Q_G	V = 560V I = 4.4A		15	20	nC	
Gate-Source Charge		Q_GS	V _{DS} = 560V, I _D = 4.4A,		3.4		nC	
Gate-Drain Charge		Q_{GD}	V _{GS} = 10 V (Note 1, 2)		7.1		nC	

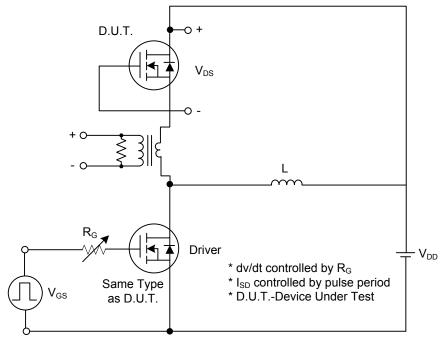
■ ELECTRICAL CHARACTERISTICS(Cont.)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT			
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS									
Drain-Source Diode Forward Voltage	V_{SD}	$V_{GS} = 0 \text{ V}, I_{S} = 4.4 \text{ A}$			1.4	V			
Maximum Continuous Drain-Source Diode Forward Current	Is				4.4	Α			
Maximum Pulsed Drain-Source Diode Forward Current	I _{SM}				17.6	Α			
Reverse Recovery Time	t _{rr}	$V_{GS} = 0 \text{ V}, I_{S} = 4.4 \text{ A},$		250		ns			
Reverse Recovery Charge	Q_{RR}	dl/dt = 100 A/µs (Note 1)		1.5		μC			

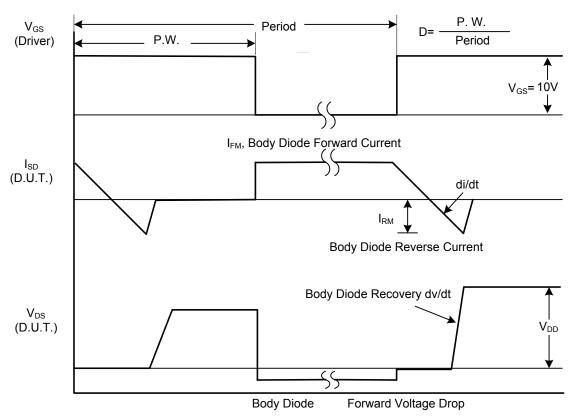
Notes: 1. Pulse Test: Pulse width≤300µs, Duty cycle≤2%

2. Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

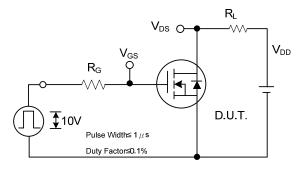


Peak Diode Recovery dv/dt Test Circuit

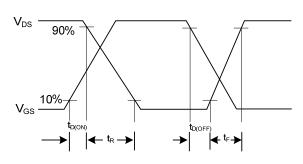


Peak Diode Recovery dv/dt Waveforms

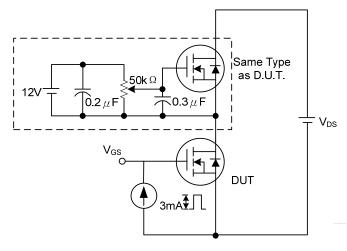
■ TEST CIRCUITS AND WAVEFORMS (Cont.)



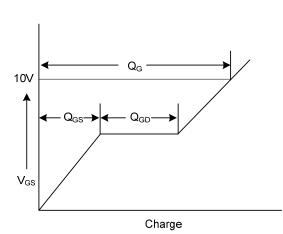
Switching Test Circuit



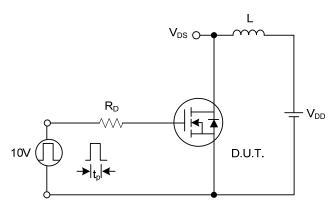
Switching Waveforms



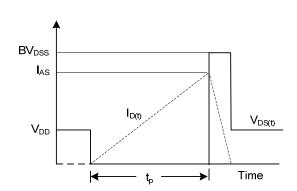
Gate Charge Test Circuit



Gate Charge Waveform

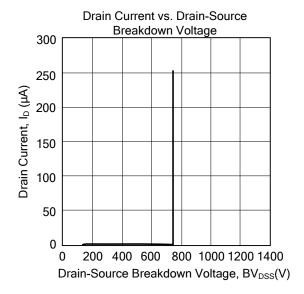


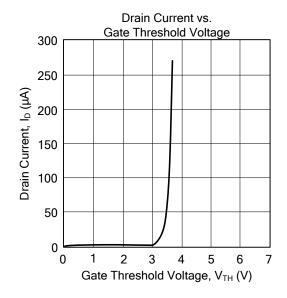
Unclamped Inductive Switching Test Circuit

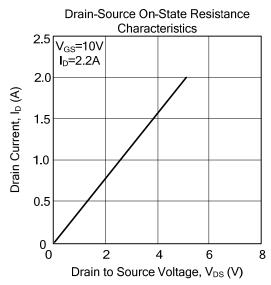


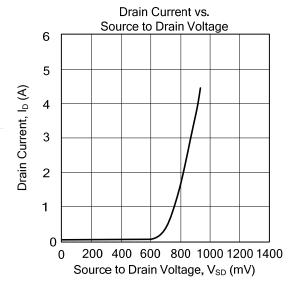
Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS









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